ON Semiconductor

Is Now

To learn more about onsemi™, please visit our website at
www.onsemi.com

MOSFET – Power, N-Channel, SUPERFET III, FRFET
650 V, 50 mΩ, 58 A

NVHL050N65S3F

Description

SUPERFET III MOSFET is ON Semiconductor's brand−new high voltage super−junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)}$ = 42 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 121 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 1119 pF)
- 100% Avalanche Tested
- AEC−Q101 Qualified and PPAP Capable
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

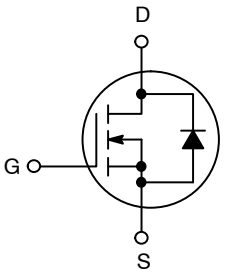
Applications

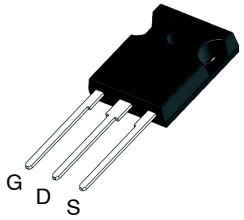
- Automotive On Board Charger HEV−EV
- Automotive DC/DC Converter HEV−EV

ON Semiconductor®

www.onsemi.com

V_{DSS}	$R_{DS(ON)}$ MAX	I_D MAX
650 V	50 mΩ	58 A





TO−247 long leads
CASE 340CX

MARKING DIAGRAM

$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Date Code (Year & Week)
&K	= Lot
NVHL050N65S3F	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain to Source Voltage		650	V
V_{GSS}	Gate to Source Voltage	– DC	±30	V
		– AC (f > 1 Hz)	±30	
I_D	Drain Current	– Continuous (T_C = 25°C)	58	A
		– Continuous (T_C = 100°C)	36	
I_{DM}	Drain Current	– Pulsed (Note 1)	145	A
E_{AS}	Single Pulsed Avalanche Energy (Note 2)		830	mJ
I_{AS}	Avalanche Current (Note 2)		7.5	A
E_{AR}	Repetitive Avalanche Energy (Note 1)		4.03	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
P_D	Power Dissipation	(T_C = 25°C)	403	W
		– Derate Above 25°C	3.23	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		–55 to +150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse−width limited by maximum junction temperature.
2. I_{AS} = 7.5 A, R_G = 25 Ω, starting T_J = 25°C.
3. $I_{SD} \le$ 29 A, di/dt ≤ 200 A/μs, $V_{DD} \le$ 400 V, starting T_J = 25°C.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.31	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NVHL050N65S3F	NVHL050N65S3F	TO−247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain−to−Source Breakdown Voltage	BV_{DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V
Drain−to−Source Breakdown Voltage	BV_{DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 150°C	700			V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	I_D = 10 mA, Referenced to 25°C		640		mV/°C
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS} = 0 V, V_{DS} = 650 V			10	μA
		V_{DS} = 520 V, T_C = 125°C		19		
Gate−to−Body Leakage Current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS} = V_{DS}, I_D = 1.7 mA	3.0		5.0	V
Threshold Temperature Coefficient	$\Delta V_{GS(th)}/\Delta T_J$	V_{GS} = V_{DS}, I_D = 1.7 mA		−8		mV/°C
Static Drain−to−Source On Resistance	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 29 A		42	50	mΩ
Forward Transconductance	g_{FS}	V_{DS} = 20 V, I_D = 29 A		32.8		S
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 400 V, f = 1 MHz		5404		pF
Output Capacitance	C_{oss}			110		
Reverse Transfer Capacitance	C_{rss}			13		
Effective Output Capacitance	$C_{oss(eff.)}$	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		1119		pF
Energy Related Output Capacitance	$C_{oss(er.)}$	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		198		pF
Total Gate Charge at 10 V	$Q_{G(TOT)}$	V_{GS} = 10 V, V_{DS} = 400 V, I_D = 29 A (Note 4)		123		nC
Threshold Gate Charge	$Q_{G(TH)}$			22.9		
Gate−to−Source Gate Charge	Q_{GS}			39.5		
Gate−to−Drain “Miller” Charge	Q_{GD}			51.4		
Equivalent Series Resistance	ESR	f = 1 MHz		1.7		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{d(on)}$	V_{GS} = 10 V, V_{DD} = 400 V, I_D = 29 A, R_g = 2.2 Ω (Note 4)		38		ns
Turn-On Rise Time	t_r			47		ns
Turn-Off Delay Time	$t_{d(off)}$			87		ns
Turn-Off Fall Time	t_f			6		ns
SOURCE−DRAIN DIODE CHARACTERISTICS						
Maximum Continuous Source−to−Drain Diode Forward Current	I_S	V_{GS} = 0 V			58	A
Maximum Pulsed Source−to−Drain Diode Forward Current	I_{SM}	V_{GS} = 0 V			145	A
Source−to−Drain Diode Forward Voltage	V_{SD}	V_{GS} = 0 V, I_{SD} = 29 A			1.3	V
Reverse Recovery Time	t_{rr}	V_{GS} = 0 V, dI_F/dt = 100 A/μs, I_{SD} = 29 A		133		ns
Charge Time	t_a			106		
Discharge Time	t_b			27		
Reverse Recovery Charge	Q_{rr}			603		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS

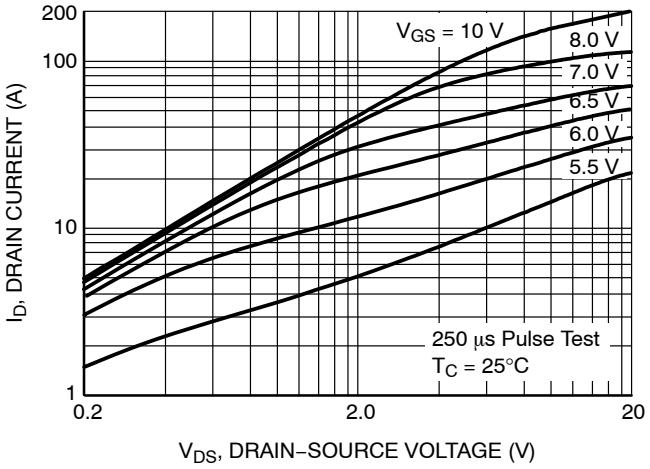


Figure 1. On−Region Characteristics

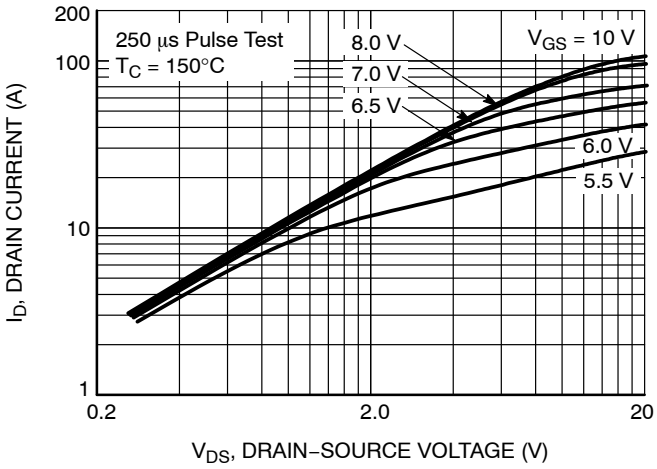


Figure 2. On−Region Characteristics

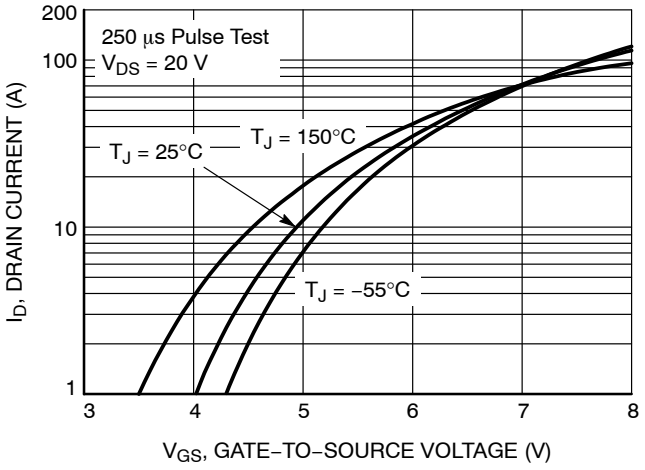


Figure 3. Transfer Characteristics

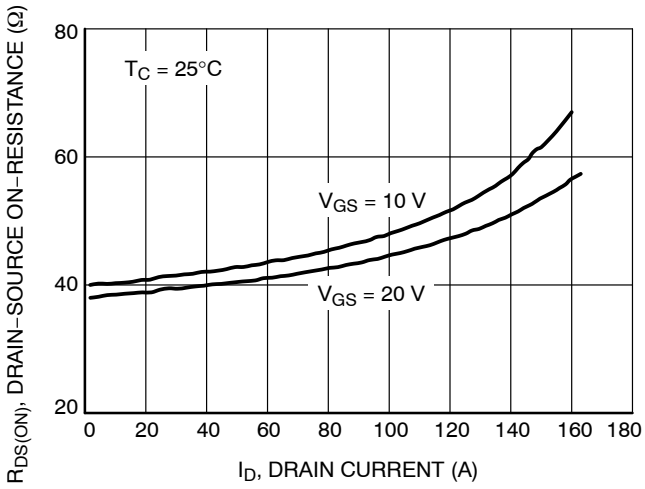


Figure 4. On−Resistance Variation vs. Drain Current and Gate Voltage

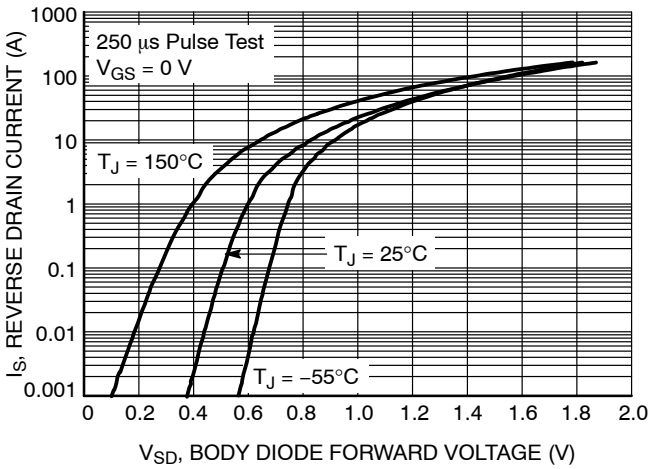


Figure 5. Body Diode Forward Voltage Variation vs. Source Current and Temperature

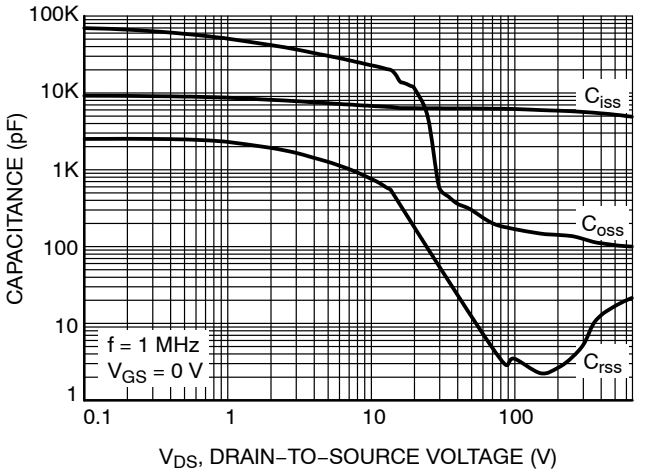


Figure 6. Capacitance Characteristics

TYPICAL CHARACTERISTICS

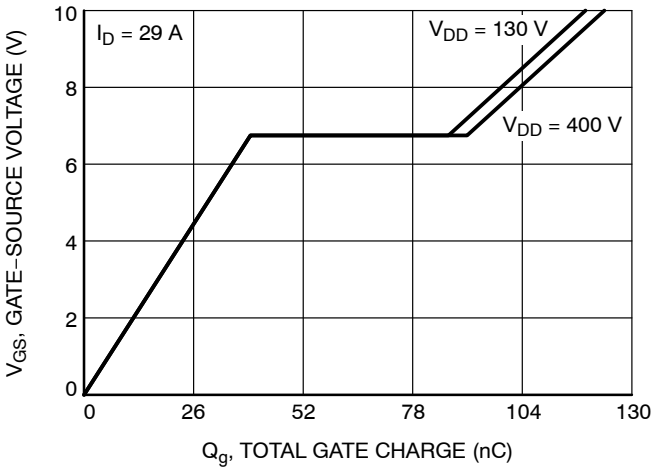


Figure 7. Gate Charge Characteristics

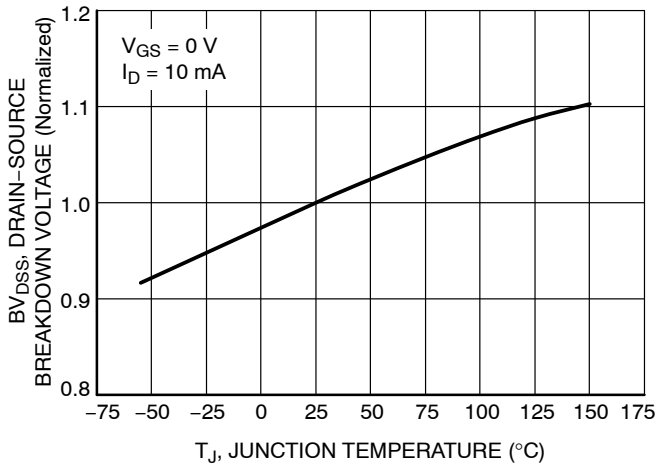


Figure 8. Breakdown Voltage Variation vs. Temperature

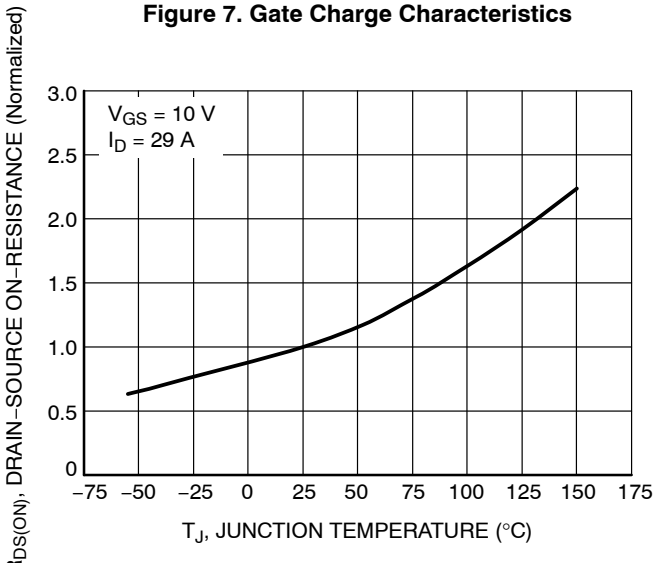


Figure 9. On−Resistance Variation vs. Temperature

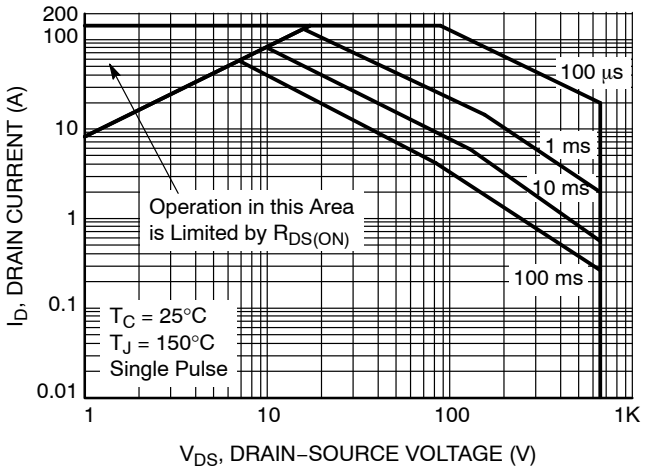


Figure 10. Maximum Safe Operating Area

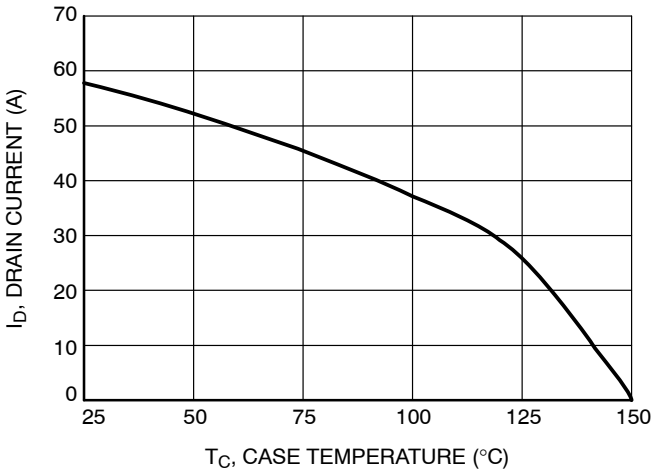


Figure 11. Maximum Drain Current vs. Case Temperature

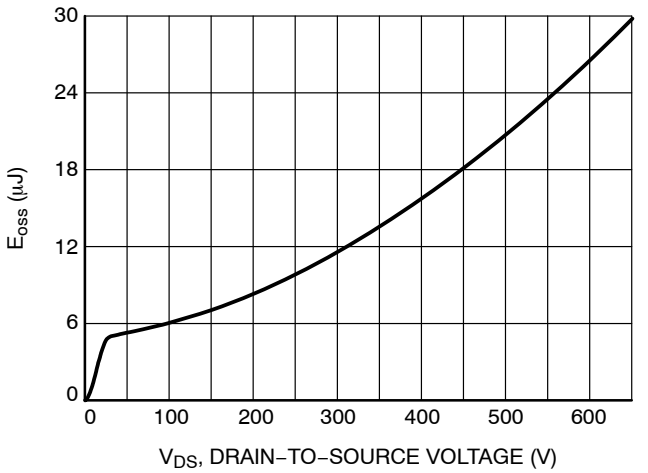


Figure 12. EOSS vs. Drain−to−Source Voltage

TYPICAL CHARACTERISTICS

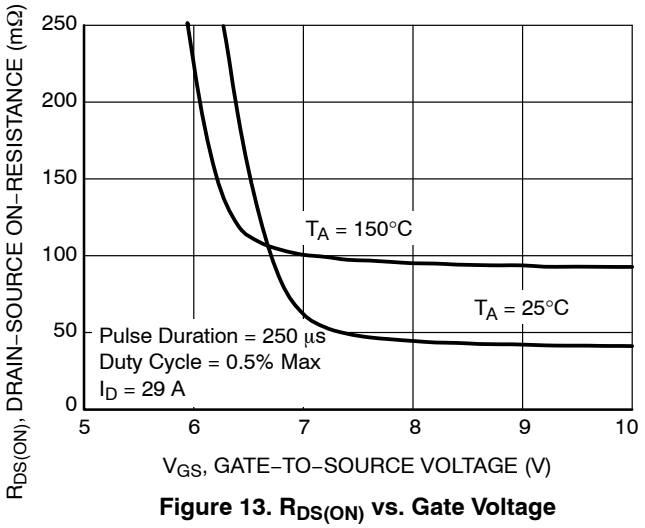


Figure 13. $R_{DS(ON)}$ vs. Gate Voltage

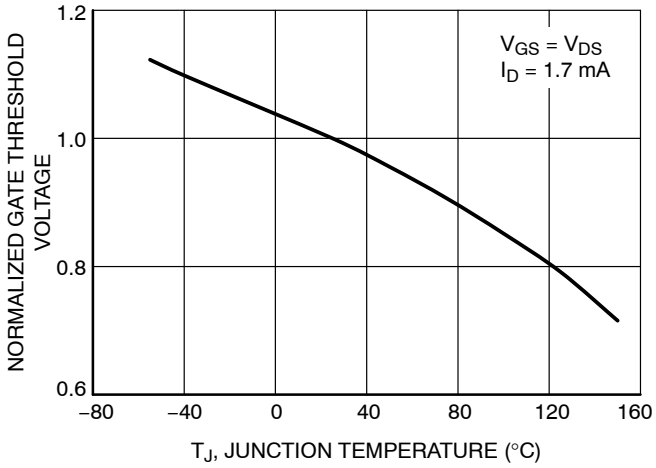


Figure 14. Normalized Gate Threshold Voltage vs. Temperature

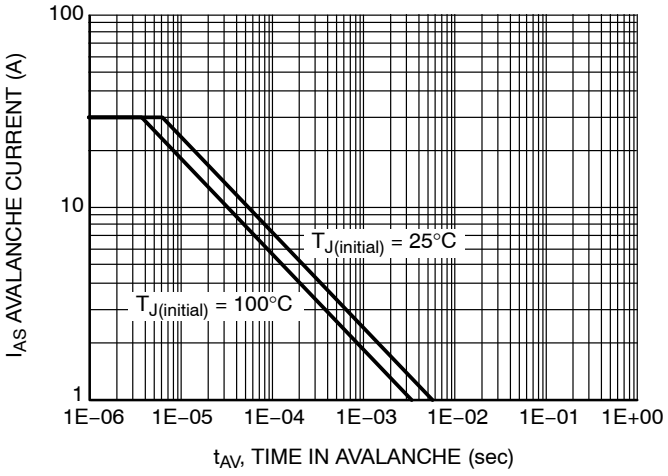


Figure 15. Unclamped Inductive Switching Capability

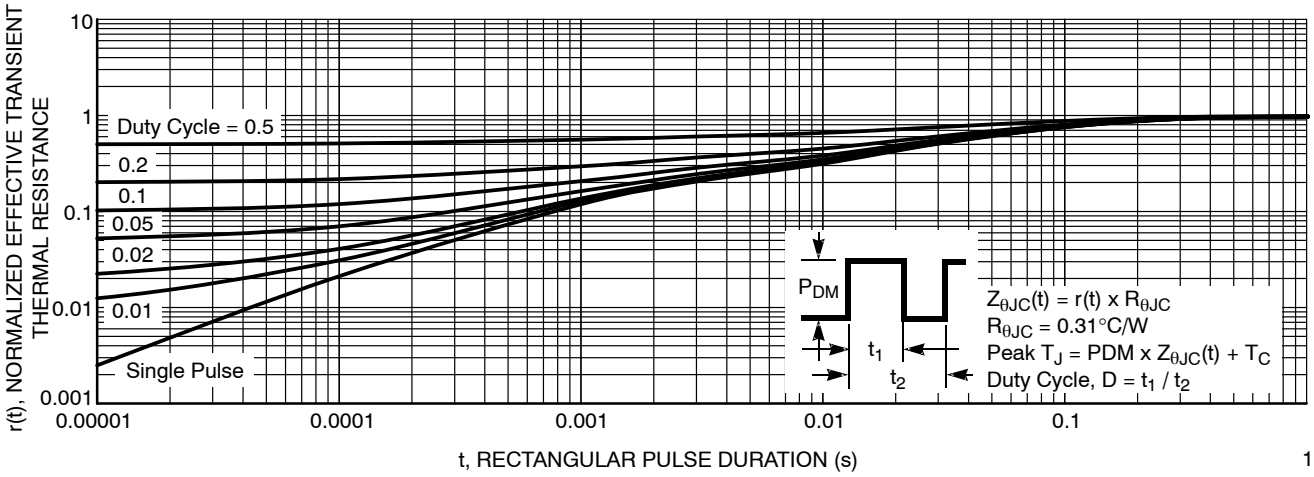
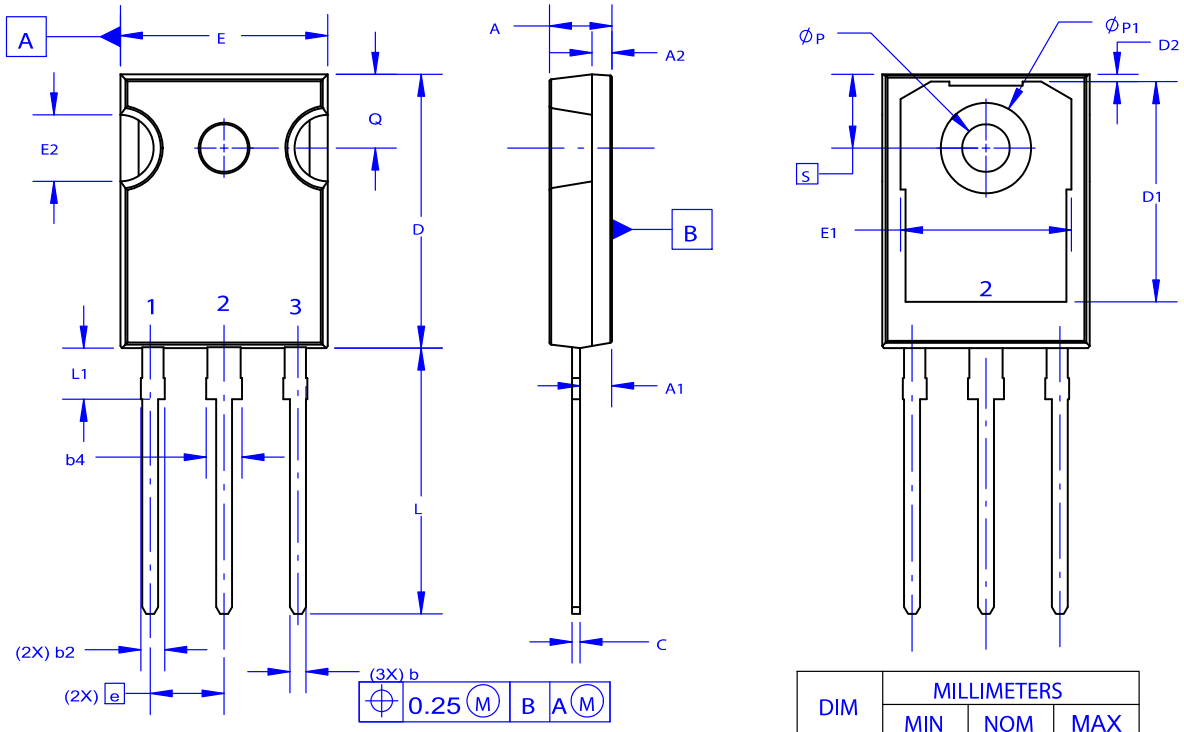


Figure 16. Transient Thermal Response Curve

PACKAGE DIMENSIONS

TO−247−3LD
CASE 340CX
ISSUE O



NOTES: UNLESS OTHERWISE SPECIFIED.

A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
e	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØP	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
ØP1	6.60	6.80	7.00

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT
North American Technical Support:
Voice Mail: 1 800−282−9855 Toll Free USA/Canada
Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:
Phone: 00421 33 790 2910
For additional information, please contact your local Sales Representative

◊

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi:
NVHL050N65S3F